# BOURNS®

- 8 A Continuous On-State Current
- 80 A Surge-Current
- Glass Passivated Wafer
- 400 V to 800 V Off-State Voltage
- Max I<sub>GT</sub> of 20 mA





Pin 2 is in electrical contact with the mounting base.

## absolute maximum ratings over operating case temperature (unless otherwise noted)

RATING			VALUE	UNIT	
	TIC116D	4	400		
Repetitive peak off-state voltage	TIC116M	V	600	V	
	TIC116S	VDRM	700		
	TIC116N		800		
	TIC116D		400	v	
Repetitive peak reverse voltage	TIC116M	V	600		
	TIC116S	V <sub>RRM</sub>	700		
	TIC116N		800		
Continuous on-state current at (or below) 70°C case temperature (see Note 1)		I <sub>T(RMS)</sub>	8	Α	
Average on-state current (180° conduction angle) at (or below) 70°C case temp	erature		5	А	
(see Note 2)		I <sub>T(AV)</sub>	5	A	
Surge on-state current at (or below) 25°C case temperature (see Note 3)		I <sub>TM</sub>	80	А	
Peak positive gate current (pulse width $\leq 300 \ \mu s$ )		I <sub>GM</sub>	3	А	
Peak gate power dissipation (pulse width $\leq 300 \ \mu s$ )		P <sub>GM</sub>	5	W	
Average gate power dissipation (see Note 4)		P <sub>G(AV)</sub>	1	W	
Operating case temperature range		T <sub>C</sub>	-40 to +110	°C	
Storage temperature range		T <sub>stg</sub>	-40 to +125	°C	
Lead temperature 1.6 mm from case for 10 seconds		TL	230	°C	

NOTES: 1. These values apply for continuous dc operation with resistive load. Above 70°C derate linearly to zero at 110°C.

2. This value may be applied continuously under single phase 50 Hz half-sine-wave operation with resistive load. Above 70°C derate linearly to zero at 110°C.

3. This value applies for one 50 Hz half-sine-wave when the device is operating at (or below) the rated value of peak reverse voltage and on-state current. Surge may be repeated after the device has returned to original thermal equilibrium.

4. This value applies for a maximum averaging time of 20 ms.

# PRODUCT INFORMATION

# TIC116 SERIES SILICON CONTROLLED RECTIFIERS



#### electrical characteristics at 25°C case temperature (unless otherwise noted)

	PARAMETER		TEST CONDITION	ONS	MIN	ТҮР	MAX	UNIT
I <sub>DRM</sub>	Repetitive peak off-state current	$V_D = rated V_{DRM}$		T <sub>C</sub> = 110°C			2	mA
I <sub>RRM</sub>	Repetitive peak reverse current	$V_{R}$ = rated $V_{RRM}$	I <sub>G</sub> = 0	T <sub>C</sub> = 110°C			2	mA
I <sub>GT</sub>	Gate trigger current	V <sub>AA</sub> = 12 V	$R_L = 100 \Omega$	t <sub>p(g)</sub> ≥ 20 μs		8	20	mA
V <sub>GT</sub>	Gate trigger voltage	V <sub>AA</sub> = 12 V t <sub>p(g)</sub> ≥ 20 µs	R <sub>L</sub> = 100 Ω	$T_{C} = -40^{\circ}C$			2.5	
		V <sub>AA</sub> = 12 V t <sub>p(g)</sub> ≥ 20 µs	R <sub>L</sub> = 100 Ω			0.8	1.5	V
		V <sub>AA</sub> = 12 V t <sub>p(g)</sub> ≥ 20 µs	R <sub>L</sub> = 100 Ω	$T_{C} = 110^{\circ}C$	0.2			
Ι <sub>Η</sub>	Holding current	$V_{AA} = 12 V$ Initiating I <sub>T</sub> = 100 mA		$T_{C} = -40^{\circ}C$			100	mA
		$V_{AA} = 12 V$ Initiating I <sub>T</sub> = 100 mA					40	n v (
V <sub>T</sub>	On-state voltage	I <sub>T</sub> = 8 A	(see Note 5)				1.7	V
dv/dt	Critical rate of rise of off-state voltage	$V_D = rated V_D$	$I_{G} = 0$	T <sub>C</sub> = 110°C	K.	400		V/µs

NOTE 5: This parameter must be measured using pulse techniques,  $t_p = 300 \ \mu$ s, duty cycle  $\leq 2 \ \%$ . Voltage sensing-contacts, separate from the current carrying contacts, are located within 3.2 mm from the device body.

#### thermal characteristics

PARAMETER	MIN	ТҮР	MAX	UNIT
R <sub>0JC</sub> Junction to case thermal resistance			3	°C/W
R <sub>0JA</sub> Junction to free air thermal resistance			62.5	°C/W

#### PRODUCT INFORMATION

# BOURNS®

## THERMAL INFORMATION



## PRODUCT INFORMATION

APRIL 1971 - REVISED SEPTEMBER 2002 Specifications are subject to change without notice.

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### **TYPICAL CHARACTERISTICS**



PRODUCT INFORMATION